



Designation: **B854 – 98 (Reapproved 2010)^{ε1} B854 – 98 (Reapproved 2016)**

Standard Guide for Measuring Electrical Contact Intermittences¹

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~~^{ε1} NOTE—Footnotes 7 and 8 were removed editorially in October 2010.~~

This standard has been approved for use by agencies of the U.S. Department of Defense.

1. Scope

1.1 The techniques described in this guide apply to electrical circuits that include one or more electrical contacts in devices such as slip rings, separable connectors, electromechanical relays or closed switch contacts. The user should determine applicability for other devices.

1.2 The range of techniques described apply to circuit discontinuities (intermittences) of durations ranging from approximately 10 nanoseconds to several seconds and of sufficient magnitude to cause alteration of the circuit function. Extension of the guide to shorter duration events may be possible with suitable instrumentation. Events of longer duration may be monitored by techniques for dc measurements such as those described in Test Methods B539 or by adaptation of methods described in this guide.

1.3 The techniques described in this guide apply to electrical circuits carrying currents typical of signal circuits. Such currents are generally less than 100 ma. Extension of these techniques to circuits carrying larger currents may be possible, but the user should evaluate applicability first.

1.4 *This standard does not purport to address all of the safety concerns, if any, associated with its use. It is the responsibility of the user of this standard to become familiar with all hazards including those identified in the appropriate Material Safety Data Sheet (MSDS)(SDS) for this product/material as provided by the manufacturer, to establish appropriate safety and health practices, and determine the applicability of regulatory limitations prior to use.*

2. Referenced Documents

2.1 ASTM Standards:²

B539 Test Methods for Measuring Resistance of Electrical Connections (Static Contacts)

B542 Terminology Relating to Electrical Contacts and Their Use

B615 Practice for Measuring Electrical Contact Noise in Sliding Electrical Contacts

B878 Test Method for Nanosecond Event Detection for Electrical Contacts and Connectors

2.2 Other Documents:

IEC Publication 512 Test 2e Contact Disturbance³

EIA-364-46 Continuity Test Procedure for Electrical Connectors⁴

3. Terminology

3.1 Terms relevant to this guide are defined in Terminology B542 except as noted in the following section.

3.2 Definitions of Terms Specific to This Standard:

3.2.1 *intermittence, n*—a transient increase in the voltage drop across a pair of electrical contacts.

¹ This guide is under the jurisdiction of ASTM Committee B02 on Nonferrous Metals and Alloys and is the direct responsibility of Subcommittee B02.11 on Electrical Contact Test Methods.

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² For referenced ASTM standards, visit the ASTM website, www.astm.org, or contact ASTM Customer Service at service@astm.org. For *Annual Book of ASTM Standards* volume information, refer to the standard's Document Summary page on the ASTM website.

³ Available from American National Standards Institute (ANSI), 25 W. 43rd St., 4th Floor, New York, NY 10036, http://www.ansi.org.

⁴ Available from Electronic Industries Association, 2001 Pennsylvania Ave NW, Washington D.C. 20006.

4. Significance and Use

4.1 This guide suggests techniques to evaluate intermittences in a contact pair while it is subjected to simulated or actual environmental stress. Such measurements are a valuable tool in predicting circuit performance under these stress conditions and in diagnosing observed problems in circuit function under such conditions.

4.2 This document is intended to provide some general guidance on the best available practices for detecting, quantifying, characterizing and reporting short duration intermittences in circuits containing electrical contacts. Certain environmental stresses such as mechanical shock, vibration or temperature change may cause intermittences. These measurement procedures include methods applicable to contacts operating under various conditions in testing or in service.

4.3 Practice B615 defines methods for measuring electrical contact noise in sliding electrical contacts. In contrast Guide B854 provides guidance to the various methods for measuring similar phenomena in static contacts.

5. Apparatus

5.1 *General Comments*—The apparatus required varies depending upon the technique selected and the parameters (such as duration and magnitude) of the intermittence that the user wants to detect. In general, the cabling must be capable of carrying signals of the speed to be detected in the study, and must be isolated from sources of noise that may cause false indications.

5.2 *Special Precautions for Measurements Involving Events Less than 1 Microsecond in Duration*—Detection of events of duration less than 1 microsecond will require special attention to the wiring of the detection circuits and instrumentation. Such attention may include using coaxial cable, shielding the apparatus from interferences and minimizing cable lengths.

5.3 *Specific Apparatus*—The apparatus required will vary depending upon the measurement method selected and the environmental stresses imposed during the test.

6. Procedure

6.1 *General Comments*—The following sections describe, in general terms, several methods that have been used to detect or measure contact intermittences. The user should select an appropriate method and adapt it as required. Table 1 presents a comparison of the attributes of the various methods. The following list covers questions that the user should answer before selecting a test method.

6.1.1 What is the definition of an intermittence in the intended application? For example, what resistance change over what time interval constitutes an intermittence, or what error occurs if the contact resistance changes, or what other definition is appropriate for the intended purpose of the test results?

6.1.2 Is it necessary to monitor more than one contact simultaneously? If so, is it acceptable to connect the contacts in series? If contacts cannot be connected in series, how many contacts must be measured simultaneously?

6.2 Test results should be reported in a format appropriate for the application and consistent with the format supplied by the test instrument.

TABLE 1 Comparison of Methods of Monitoring Electrical Contact Intermittences

Method	Typical Number of Channels	Typical Event Characterization	Possible Advantages
Oscilloscope	1, 2 or 4	ΔV vs time	Detailed characterization of each event
Oscilloscope	1, 2 or 4	ΔV vs time	Detailed characterization of each event
Custom Circuitry	1 per circuit	Presence or absence of one or more events during a preselected monitoring interval, such events defined as above a preselected threshold of ΔR and duration, the number of events during the interval may or may not be recorded.	Ability to closely model actual circuit conditions, allows use of various technologies in the transmitting and receiving devices
Event Detector	1 to 64	Presence or absence of one or more events during a preselected monitoring interval, such events defined as above a preselected threshold of ΔR and duration, but the number of events during the interval is not recorded.	Multichannel capability, selection of thresholds for events to be counted
Bit Error Rate	1	Ratio of errors to number of bits transmitted	The format of the results is readily applicable to ranking of interconnection devices with respect to transmission quality for a specific signal format